

February 1991 Revised February 2000

# DM74ALS133 13-Input NAND Gate

## **General Description**

This device contains a single gate, which performs the logic NAND function.

#### **Features**

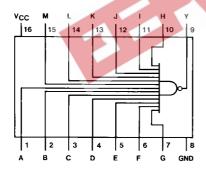
- Switching specifications at 50 pF
- $\blacksquare$  Switching specifications guaranteed over full temperature and  $V_{CC}$  range
- Advanced oxide-isolated, ion-implanted Schottky TTL process
- Functionally and pin for pin compatible with Schottky and low power Schottky TTL counterpart
- Improved AC performance over Schottky and low power Schottky counterparts

# **Ordering Code:**

Order Number	Package Number	Package Des <mark>cription</mark>				
DM74ALS133M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow				
DM74ALS133N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide				

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

### **Connection Diagram**



### **Function Table**

# Y = ABCDEFGHIJKLM

Inputs	Output			
A thru M	Υ			
All Inputs H	L			
One or More Input L	Н			

H = HIGH Logic Level L = LOW Logic Level

## **Absolute Maximum Ratings**(Note 1)

Supply Voltage 7V Input Voltage 7V Operating Free Air Temperature Range  $0^{\circ}$ C to  $+70^{\circ}$ C

Storage Temperature Range -65°C to +150°C

Typical  $\theta_{JA}$ 

N Package  $85.0^{\circ}$ C/W M Package  $111.0^{\circ}$ C/W

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings.

85.0°C/W 111.0°C/W 111.0°C/W

# **Recommended Operating Conditions**

Symbol	Parameter	Min	Nom	Max	Units
V <sub>CC</sub>	Supply Voltage	4.5	5	5.5	V
V <sub>IH</sub>	HIGH Level Input Voltage	2			V
V <sub>IL</sub>	LOW Level Input Voltage			0.8	V
Гон	HIGH Level Output Current		40.	-0.4	mA
I <sub>OL</sub>	LOW Level Output Current		4 15 14	8	mA
T <sub>A</sub>	Free Air Operating Temperature	0 2	. 70	70	°C

#### **Electrical Characteristics**

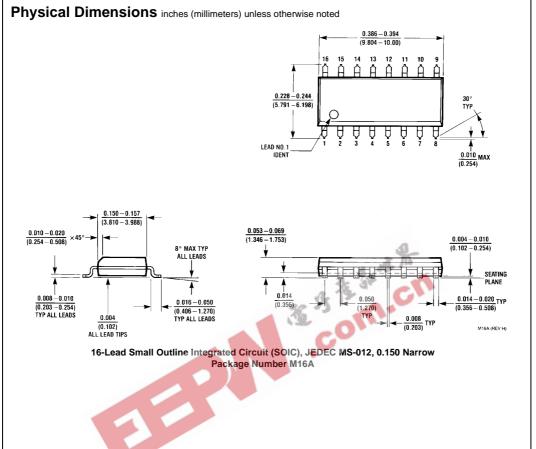
over recommended operating free air temperature range. All typical values are measured at  $V_{CC} = 5V$ ,  $T_A = 25^{\circ}C$ .

Symbol	Parameter	Conditions	,0	Min	Тур	Max	Units
V <sub>IK</sub>	Input Clamp Voltage	$V_{CC} = 4.5V$ , $I_I = -18 \text{ mA}$				-1.5	V
V <sub>OH</sub>	HIGH Level	$I_{OH} = -0.4 \text{ mA}$ V <sub>CC</sub> = 4.5V to 5.5V		V <sub>CC</sub> - 2			V
	Output Voltage			VCC - 2			V
V <sub>OL</sub>	LOW Level	V <sub>CC</sub> = 4.5V	I <sub>OL</sub> = 4 mA		0.25	0.4	V
	Output Voltage		I <sub>OL</sub> = 8 mA		0.35	0.5	V
I	Input Current @ Maximum	V <sub>CC</sub> = 5.5V, V <sub>IH</sub> = 7V				0.1	mA
	Input Voltage					0.1	IIIA
I <sub>IH</sub>	HIGH Level Input Current	$V_{CC} = 5.5V, V_{IH} = 2.7V$				20	μΑ
I <sub>IL</sub>	LOW Level Input Current	$V_{CC} = 5.5V, V_{IL} = 0.4V$				-0.1	mA
Io	Output Drive Current	V <sub>CC</sub> = 5.5V	V <sub>O</sub> = 2.25V	-30		-112	mA
I <sub>CC</sub>	Supply Current	V <sub>CC</sub> = 5.5V	Outputs HIGH		0.24	0.34	mA
			Outputs LOW		0.56	0.8	mA

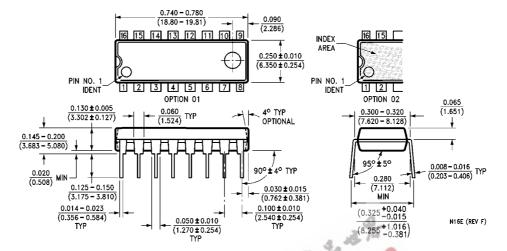
#### **Switching Characteristics**

over recommended operating free air temperature range

Symbol	Parameter	Conditions	Min	Max	Units
t <sub>PLH</sub>	Propagation Delay Time	V <sub>CC</sub> = 4.5V to 5.5V	3	11	ns
	LOW-to-HIGH Level Output	$R_L = 500\Omega$	3		110
t <sub>PHL</sub>	Propagation Delay Time	$C_L = 50 \text{ pF}$	5	25	ns
	HIGH-to-LOW Level Output		3	23	115



# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N16E

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the
- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com